

Special Issue

Innovations in Superconductor and Magnetic Fundamentals, Technologies and Applications

Message from the Guest Editor

The journal is open to receiving submissions on topics covering different aspects of superconductivity and magnetism, their fundamentals, techniques, and applications. It is a great chance for researchers to present their results, to contribute to the understanding of the phenomena, to show their architecture and engineering, and to nurture ideas in this area. The topics of superconductivity, magnetism, and the interaction between these two phenomena are presented in this Special Issue of the journal, combining basic science, state-of-the-art discoveries, and the latest advances in technologies.

Guest Editor

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The unique journal *Inventions* is different from all other journals. Many scholars spend their lives publishing research papers in many different journals, but most of these journals do not help scholars collate and analyze their results or assist in promoting them to a relevant industry. However, *Inventions* will help authors not only to publish their papers in the journal, but also to promote their research results to industry and assist them in realizing the purpose of technology transfer. In the future, *Inventions* will help authors to evaluate their technology license fees based on the valuation theory and approaches and also help authors to show their patents and technologies on a network transaction platform.

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